

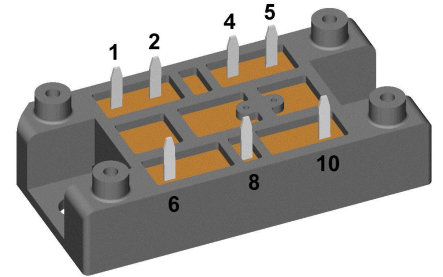
Standard Rectifier Module

| | |
|-------------------------|-------|
| 3~ Rectifier | |
| $V_{RRM} =$ | 800 V |
| $I_{DAV} =$ | 80 A |
| $I_{FSM} =$ | 600 A |

3~ Rectifier Bridge

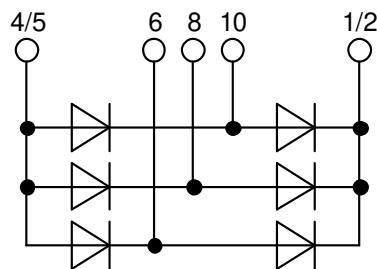
Part number

VUO80-08NO1



Backside: isolated

 E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

Applications:

- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: V1-A-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Disclaimer Notice

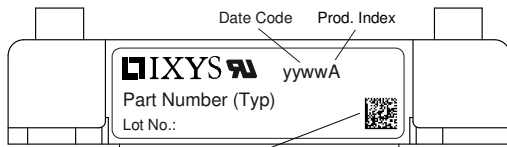
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| Rectifier | | | | Ratings | | | |
|------------|--|---|-------------|------------------------------|------|------|-------------------|
| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
| V_{RSM} | max. non-repetitive reverse blocking voltage | | | | | 900 | V |
| V_{RRM} | max. repetitive reverse blocking voltage | | | | | 800 | V |
| I_R | reverse current | $V_R = 800\text{ V}$ | | $T_{VJ} = 25^\circ\text{C}$ | | 40 | μA |
| | | $V_R = 800\text{ V}$ | | $T_{VJ} = 150^\circ\text{C}$ | | 1.5 | mA |
| V_F | forward voltage drop | $I_F = 30\text{ A}$ | | $T_{VJ} = 25^\circ\text{C}$ | | 1.14 | V |
| | | $I_F = 90\text{ A}$ | | | | 1.48 | V |
| | | $I_F = 30\text{ A}$ | | $T_{VJ} = 125^\circ\text{C}$ | | 1.06 | V |
| | | $I_F = 90\text{ A}$ | | | | 1.51 | V |
| I_{DAV} | bridge output current | $T_C = 110^\circ\text{C}$ | rectangular | $T_{VJ} = 150^\circ\text{C}$ | | 80 | A |
| V_{FO} | threshold voltage | } for power loss calculation only | | $T_{VJ} = 150^\circ\text{C}$ | | 0.81 | V |
| r_F | slope resistance | | | | | 7.8 | m Ω |
| R_{thJC} | thermal resistance junction to case | | | | | 1.1 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | | | 0.3 | | K/W |
| P_{tot} | total power dissipation | | | $T_C = 25^\circ\text{C}$ | | 110 | W |
| I_{FSM} | max. forward surge current | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ | | $T_{VJ} = 45^\circ\text{C}$ | | 600 | A |
| | | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | | $V_R = 0\text{ V}$ | | 650 | A |
| | | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ | | $T_{VJ} = 150^\circ\text{C}$ | | 510 | A |
| | | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | | $V_R = 0\text{ V}$ | | 550 | A |
| I^2t | value for fusing | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ | | $T_{VJ} = 45^\circ\text{C}$ | | 1.80 | kA ² s |
| | | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | | $V_R = 0\text{ V}$ | | 1.76 | kA ² s |
| | | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ | | $T_{VJ} = 150^\circ\text{C}$ | | 1.30 | kA ² s |
| | | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | | $V_R = 0\text{ V}$ | | 1.26 | kA ² s |
| C_J | junction capacitance | $V_R = 400\text{ V}; f = 1\text{ MHz}$ | | $T_{VJ} = 25^\circ\text{C}$ | | 18 | pF |



| Package V1-A-Pack | | | | Ratings | | | |
|-------------------|-------------------------------|---|------|---------|------|------|--|
| Symbol | Definition | Conditions | min. | typ. | max. | Unit | |
| I_{RMS} | RMS current | per terminal | | | 100 | A | |
| T_{VJ} | virtual junction temperature | | -40 | | 150 | °C | |
| T_{op} | operation temperature | | -40 | | 125 | °C | |
| T_{stg} | storage temperature | | -40 | | 125 | °C | |
| Weight | | | | 37 | | g | |
| M_D | mounting torque | | 2 | | 2.5 | Nm | |
| $d_{Spp/App}$ | creepage distance on surface | terminal to terminal | 6.0 | | | mm | |
| $d_{Spb/Apb}$ | striking distance through air | terminal to backside | 12.0 | | | mm | |
| V_{ISOL} | isolation voltage | t = 1 second 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA | 3600 | | | V | |
| | | t = 1 minute | 3000 | | | V | |



Data Matrix: Typ (1-19), DC+Prod.Index (20-25), FKT# (26-31)
leer (33), lld.# (33-36)

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | VUO80-08NO1 | VUO80-08NO1 | Blister | 24 | 516847 |

Equivalent Circuits for Simulation

* on die level

$T_{VJ} = 150^{\circ}C$

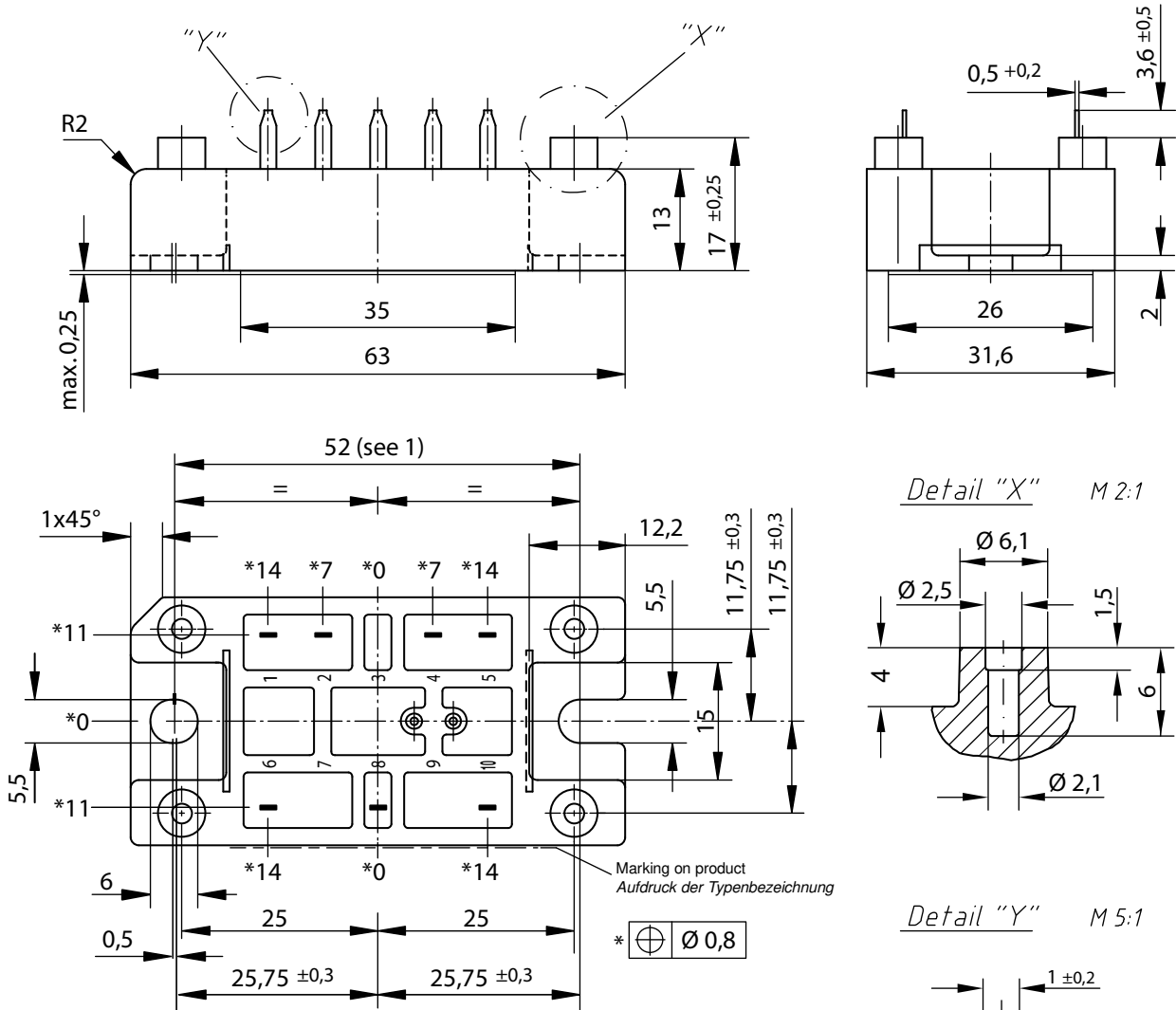


Rectifier

| | | | |
|--------------|--------------------|------|----|
| $V_{0\ max}$ | threshold voltage | 0.81 | V |
| $R_{0\ max}$ | slope resistance * | 6.6 | mΩ |

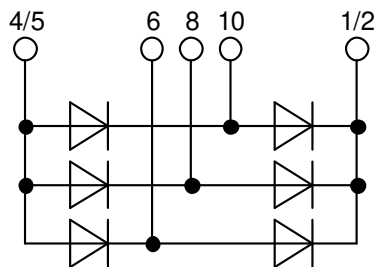


Outlines V1-A-Pack



Remarks / Bemerkungen:

1. Nominal distance mounting screws on heat sink: 52 mm / Nennabstand Befestigungsschrauben auf Kühlkörper: 52 mm
 2. General tolerance / Allgemeintoleranz: DIN ISO 2768 -T1-c
 3. Surface treatment of pins: tin plated (Sn) in hot dip / Oberflächenbehandlung der Pins: verzinkt (Sn) im Tauchbad
 4. Detail X: EJOT PT® self-tapping screws (dimension K25) to be recommended for mounting on PCB ^L
selbstschneidende Schraube (Größe K25) empfohlen für die PCB-Montage
- Take care on the maximum screw length according to board thickness and the maximum hole depth of 6 mm^L
Bei der Wahl der Schraubenlänge die PCB-Dicke und die maximale Lochtiefe von 6mm beachten
- Recommended mounting torque: 1.5 Nm / Empfohlenes Drehmoment: 1.5 Nm





Rectifier

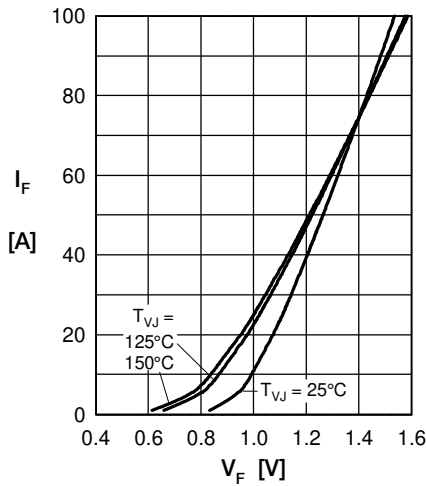


Fig. 1 Forward current vs. voltage drop per diode

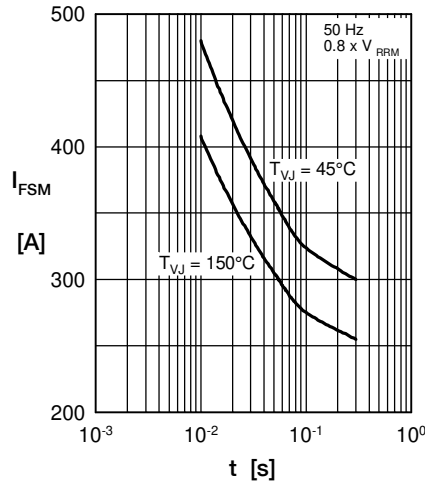


Fig. 2 Surge overload current vs. time per diode

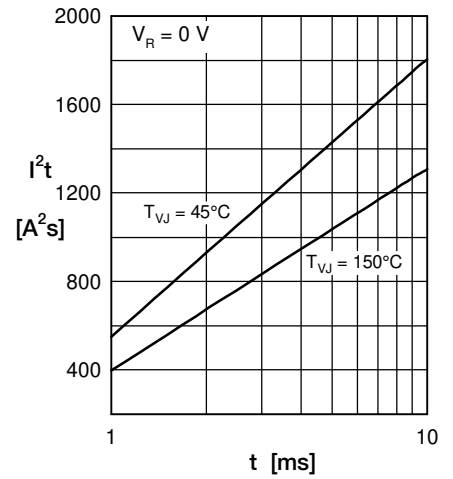


Fig. 3 I^2t vs. time per diode

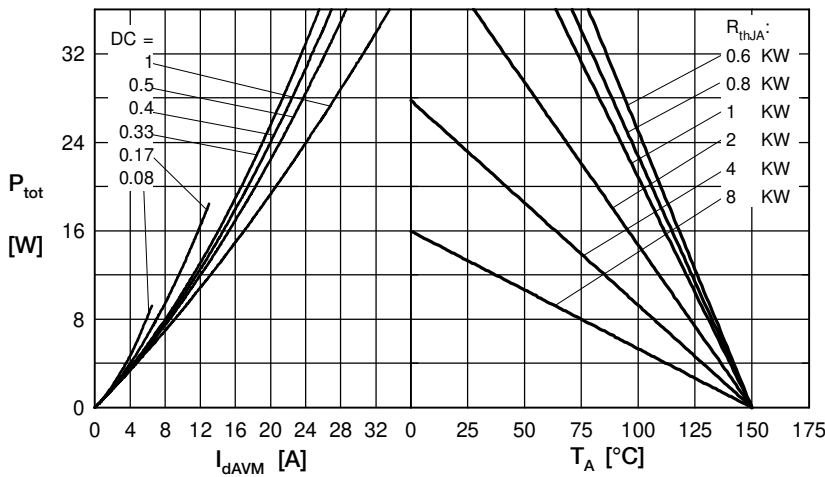


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

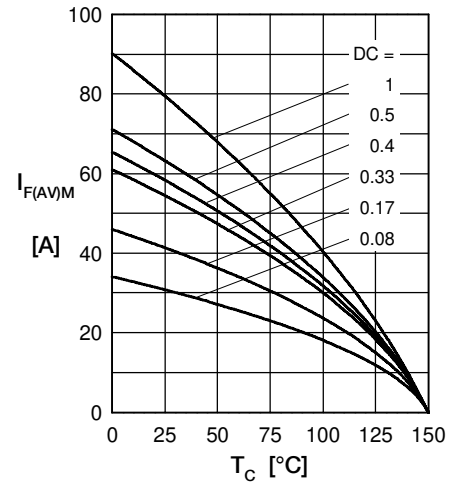


Fig. 5 Max. forward current vs. case temperature per diode

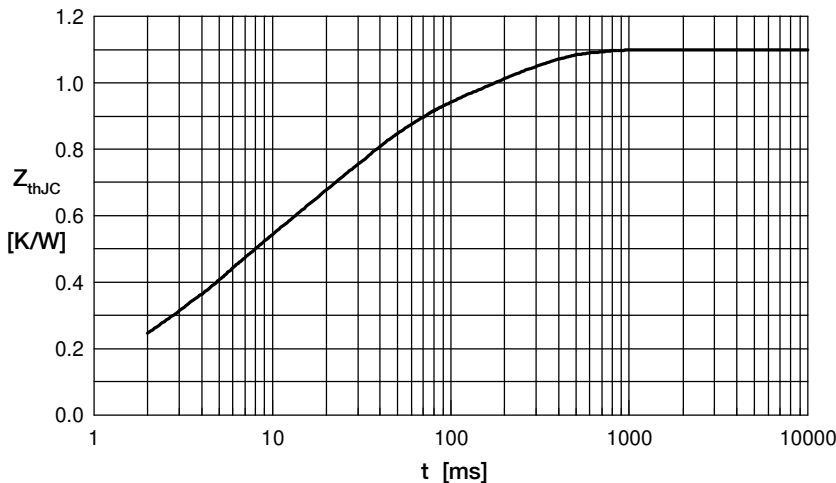


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for Z_{thJC} calculation:

| i | R_{th} (K/W) | t_i (s) |
|---|----------------|-----------|
| 1 | 0.0607 | 0.0004 |
| 2 | 0.1230 | 0.00256 |
| 3 | 0.2305 | 0.0045 |
| 4 | 0.4230 | 0.0242 |
| 5 | 0.2628 | 0.1800 |

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Тестирование поставляемой продукции.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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